



KPGB-0607VWA1ZGF

0.65 x 0.65 x 0.25 mm Bi-Color Surface Mount LED



DESCRIPTIONS

- The source color devices are made with InGaN on Sapphire substrate Light Emitting Diode
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

FEATURES

- 0.65 mm x 0.65 mm SMD LED, 0.25 mm thickness
- Low power consumption
- Package: 4000 pcs / reel
- · Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

APPLICATIONS

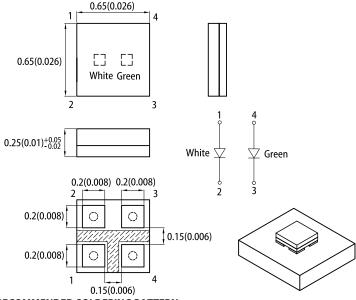
- Backlight
- · Status indicator
- · Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

ATTENTION

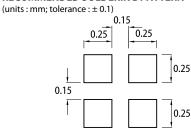
Observe precautions for handling electrostatic discharge sensitive devices



PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN



Mask open area ratio: 80% Mask thickness: 80~100um

- All dimensions are in millimeters (inches).
 Tolerance is ±0.1(0.004") unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 5mA [2]		Viewing Angle [1]	
			Min.	Тур.	201/2	
KDOD OCOZNANA AZOF	White (InGaN)	Yellow Fluorescent	30	165		
KPGB-0607VWA1ZGF	Green (InGaN)		50	200	140°	

Notes.

1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity / luminous flux: +/-15%.

3. Luminous intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C (WHITE)

Parameter	Symbol	Emitting Color	Value		Unit
Farameter	Symbol	Emitting Color	Тур.		
Chromaticity Coordinates x I _F = 5mA	x ^[1]	White	0.31	-	-
Chromaticity Coordinates y I _F = 5mA	y ^[1]	White	0.31	-	-
Capacitance	С	White	100	-	pF
Forward Voltage I _F = 5mA	V _F ^[2]	White	2.9	3.2	V
Reverse Current (V _R = 5V)	I _R	White	-	50	μΑ
Temperature Coefficient of x I_F = 5mA, -10°C \leq T \leq 85°C	TC _X	White	-0.18	-	10 ⁻³ /°C
Temperature Coefficient of y I_F = 5mA, -10°C \leq T \leq 85°C	TC _Y	White	-0.19	-	10 ⁻³ /°C
Temperature Coefficient of V_F $I_F = 5mA, -10^{\circ}C \le T \le 85^{\circ}C$	TC _V	White	-3.0	-	mV/°C

Notes:

ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C (GREEN)

Parameter	Sumbol Emitting Color	Value		Unit		
Parameter	Symbol Emitting Color		Тур.	Max.	Oill	
Wavelength at Peak Emission I _F = 5mA	λ_{peak}	Green	515	-	nm	
Dominant Wavelength I _F = 5mA	λ _{dom} ^[1]	Green	525	-	nm	
Spectral Bandwidth at 50% Φ REL MAX I _F = 5mA	Δλ	Green	30	-	nm	
Capacitance	С	Green	45	-	pF	
Forward Voltage I _F = 5mA	V _F ^[2]	Green	2.85	3.3	V	
Reverse Current (V _R = 5V)	I _R	Green	-	50	μΑ	
Temperature Coefficient of λ_{peak} I _F = 5mA, -10°C ≤ T ≤ 85°C	$TC_{\lambda peak}$	Green	0.05	-	nm/°C	
Temperature Coefficient of λ_{dom} I _F = 5mA, -10°C \leq T \leq 85°C	TC_{\lambdadom}	Green	0.03	-	nm/°C	
Temperature Coefficient of V_F I_F = 5mA, -10°C \leq T \leq 85°C	TC _V	Green	-3.0	-	mV/°C	

Notes:

Notes.

1. Measurement tolerance of the chromaticity coordinates is ±0.01.

2. Forward voltage: ±0.1V.

3. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

^{1.} The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd: ±1nm.)
2. Forward voltage: ±0.1V.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.





ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol		lue	Unit
Farameter	Symbol	White	Green	Offic
Power Dissipation	P _D ^[1]	35		mW
Reverse Voltage	V_R	5	5	V
Junction Temperature	T _j	115	115	°C
Operating Temperature	T _{op}	-40 to +85		°C
Storage Temperature	T _{stg}	-40 to +100		°C
DC Forward Current	I _F ^[2]	10	10	mA
Peak Forward Current	I _{FP} ^[3]	50	50	mA
Electrostatic Discharge Threshold (HBM)	-	250	450	V
Thermal Resistance (Junction / Ambient)	R _{th JA} [4]	720	780	°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} ^[4]	580	650	°C/W

Notes:

1. Within 35mW when multiple chips are lightened

2. The maximum ratings are valid for the case of lighting a single chip
When two chips are lit at the same time, each chip should be driven at a current lower than 50% of the absolute maximum ratings

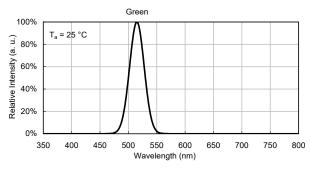
3. Duty Cycle ≤ 1 / 20, Pulse Width = 1ms.

4. R<sub>th, 14, R_{th, 15} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad).

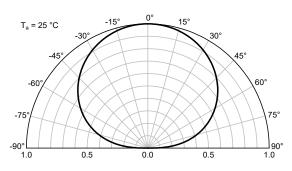
5. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.</sub>

TECHNICAL DATA

RELATIVE INTENSITY vs. WAVELENGTH



SPATIAL DISTRIBUTION

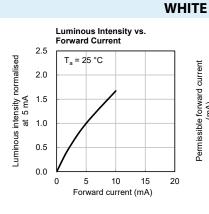


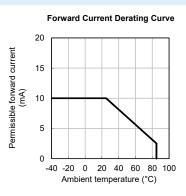


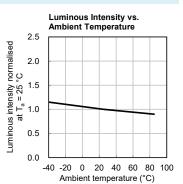


TECHNICAL DATA

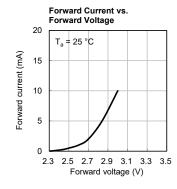
Forward Current vs. Forward Voltage 20 T_a = 25 °C Forward current (mA) 15 10 5 2.3 2.5 2.7 2.9 3.1 3.3 3.5 Forward voltage (V)

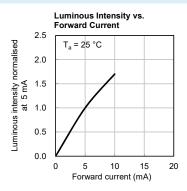


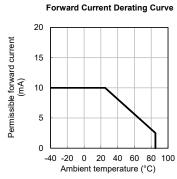


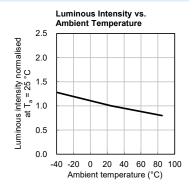


GREEN

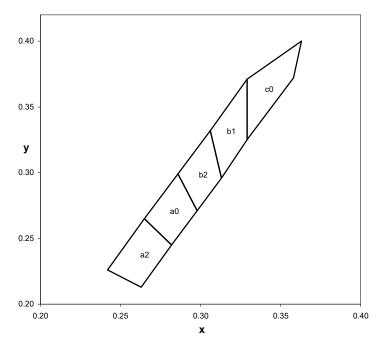








CIE CHROMATICITY DIAGRAM



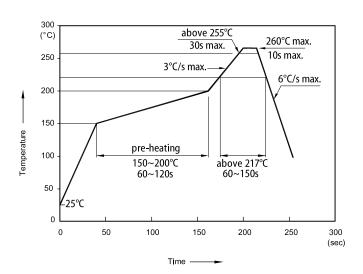
х	У		x	у
0.263	0.213	-0	0.282	0.245
0.282	0.245		0.298	0.271
0.265		au	0.286	0.299
0.242	0.226		0.265	0.265
0.298	0.271	b1	0.313	0.296
0.313	0.296		0.329	0.325
0.306	0.332		0.329	0.371
0.286	0.299		0.306	0.332
0.329	0.325			
0.358	0.372			
0.363	0.400			
0.329	0.371			
	0.263 0.282 0.265 0.242 0.298 0.313 0.306 0.286 0.329 0.358 0.363	0.263	0.263	0.263

Notes. Shipment may contain more than one chromaticity regions. Orders for single chromaticity region are generally not accepted. Measurement tolerance of the chromaticity coordinates is ±0.01.



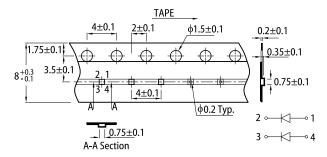


REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

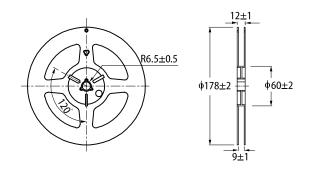


- Don't cause stress to the LEDs while it is exposed to high temperature.
 The maximum number of reflow soldering passes is 2 times.
 Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

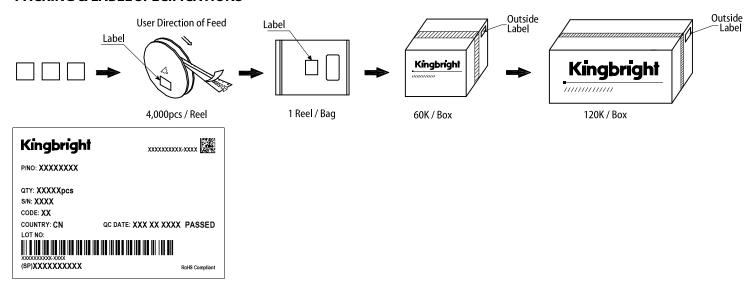
TAPE SPECIFICATIONS (units:mm)



REEL DIMENSION (units: mm)



PACKING & LABEL SPECIFICATIONS



- The information included in this document reflects representative usage scenarios and is intended for technical reference only
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If
- customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

 The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening
- liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.

 The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright.

